

Low-Stress Silicon Cladding for Surface Finishing Large UVOIR Mirrors, Phase II

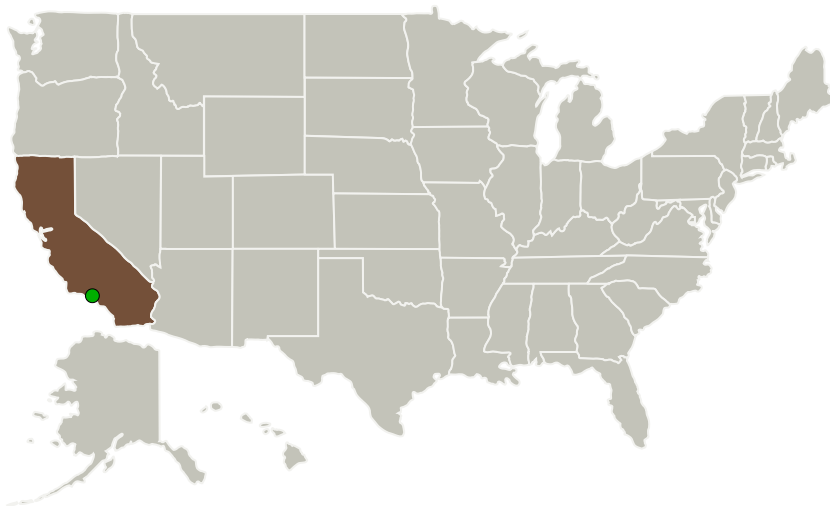
Completed Technology Project (2014 - 2016)




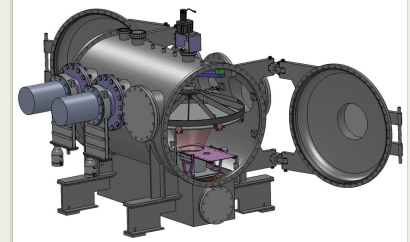
Project Introduction

In this Phase I research, ZeCoat Corporation demonstrated a low-stress silicon cladding process for surface finishing large UVOIR mirrors. A polishable cladding is desired for SiC optics so they may be figured in less time, and so they may be polished to levels suitable for UVOIR astronomy. ZeCoat has filed a provisional US patent application for the technology. The proposed process is directly scalable to SiC mirrors several meters in diameter. The process is based on a novel, low temperature, ion-assisted, evaporation technique (IAD), whereby the coating stress of a silicon film may be manipulated from compressive to tensile, in order to produce a near-zero net stress for the complete layer. A Si cladding with little intrinsic stress is essential to allow thick coatings to be manufactured without cracking. A low stress coating also minimizes substrate bending that would otherwise distort the figure of very lightweight mirrors.

Primary U.S. Work Locations and Key Partners



| Organizations Performing Work | Role | Type | Location |
|--|-------------------------|-------------|----------------------|
| ZeCoat Corporation | Lead Organization | Industry | Torrance, California |
|  Jet Propulsion Laboratory(JPL) | Supporting Organization | NASA Center | Pasadena, California |



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Primary U.S. Work Locations

California

Project Transitions

 **April 2014:** Project Start

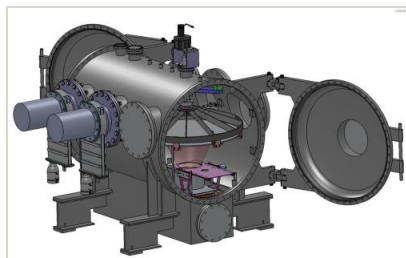
 **April 2016:** Closed out

Closeout Summary: Low-Stress Silicon Cladding for Surface Finishing Large UVOIR Mirrors, Phase II Project Image

Closeout Documentation:

- Final Summary Chart Image(<https://techport.nasa.gov/file/137642>)

Images



Briefing Chart Image

Low-Stress Silicon Cladding for Surface Finishing Large UVOIR Mirrors, Phase II
(<https://techport.nasa.gov/image/135614>)

Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Organization:

ZeCoat Corporation

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer

Project Management

Program Director:

Jason L Kessler

Program Manager:

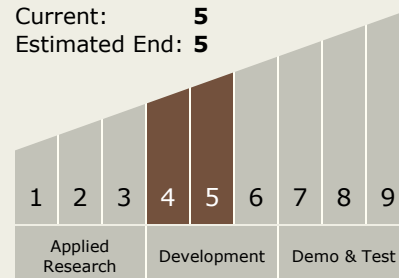
Carlos Torrez

Principal Investigator:

David Sheik

Technology Maturity (TRL)

Start: 4
Current: 5
Estimated End: 5



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Technology Areas

Primary:

- TX08 Sensors and Instruments
 - └ TX08.2 Observatories
 - └ TX08.2.1 Mirror Systems

Target Destinations

The Sun, Earth, The Moon, Mars, Others Inside the Solar System, Outside the Solar System